

## **Product Change Notification: NTDO-13QSSF734**

### Date:

18-Sep-2025

## **Product Category:**

8-Bit Microcontrollers

## **Notification Subject:**

CCB 6186 Final Notice: Qualification of MP3A as an additional assembly site for ATtiny88, ATmega328P, ATtiny861A, ATmega168PA, ATtiny461A, ATtiny261A, ATtiny48, ATmega88PA, ATmega48PA, AT90PWM81, AT90PWM81EP and AT90PWM81OS device families available in 32L VQFN (5x5x0.9mm) package using CuPdAu bond wire material.

### **Affected CPNs:**

NTDO-13QSSF734\_Affected\_CPN\_09182025.pdf NTDO-13QSSF734\_Affected\_CPN\_09182025.csv

**PCN Status:** Final Notification

**PCN Type:** Manufacturing Change

**Microchip Parts Affected:** Please open one of the files found in the Affected CPNs section. Note: For your convenience Microchip includes identical files in two formats (.pdf and .xls)

**Description of Change:** Qualification of MP3A as an additional assembly site for ATtiny88, ATmega328P, ATtiny861A, ATmega168PA, ATtiny461A, ATtiny261A, ATtiny48, ATmega88PA, ATmega48PA, AT90PWM81, AT90PWM81EP and AT90PWM81OS device families available in 32L VQFN (5x5x0.9mm) package using CuPdAu bond wire material.

### **Pre and Post Summary Changes:**

	Pre Change		Post Change					
Assembly Site	Microchip	Microchip	Microchip	Microchip	Microchip			
	Technology	Technology	Technology	Technology	Technology			
	Thailand	Thailand	Thailand	Thailand	Inc.			
	(HQ)	(Branch)	(HQ)	(Branch)	(MPHIL-3)			
	(MTAI)	(MMT)	(MTAI)	(MMT)	(MP3A)			

Wire Material	Au	Au	Au	Au	CuPdAu	
Die Attach Material	3280	3280	3280	3280	3280	
Molding Compound Material	G700LTD	G700LTD	G700LTD	G700LTD	G700LTD	
Lead-Frame Material	C194	C194	C194	C194	C194	
Lead-Frame Paddle Size	150x150 mils					
DAP Surface Prep	Bare Cu					

Impacts to Datasheet: None

**Change Impact:** None

Reason for Change: To improve productivity by qualifying MP3A as an additional assembly site.

**Change Implementation Status:** In Progress

Estimated First Ship Date: 19 October 2025 (date code: 2542)

Note Below EFSD: Note: Please be advised that after the estimated first ship date customers may

receive pre and post change parts.

# **Timetable Summary:**

	March 2023					September 2025				October 2025					
Workweek	9	10	11	12	13	>	36	37	38	39	40	41	42	43	44
Initial PCN Issue Date				x											
Qual Report Availability									X						
Final PCN Issue Date									X						
Estimated Implementation Date														X	

Method to Identify Change: Traceability Code

**Qualification Report:** Please open the attachments included with this PCN labeled as PCN\_#\_Qual\_Report.

**Revision History:** March 19, 2023: Issued initial notice.

March 29, 2023: Removed duplicates in NTDO-13QSSF734 Affected CPN.

September 18, 2025: Issued final notification. Attached the Qualification Report. Provided estimated first ship date to be on October 19, 2025. Added CPNs AT90PWM81-16MF, AT90PWM81EP-16MN, AT90PWM81-16MN and AT90PWM81OS-B16MNR in the affected CPN list. Updated the notification subject and description of change to include AT90PWM81, AT90PWM81EP and AT90PWM81OS device families.

**Note:** The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable product.

#### **Attachments:**

PCN\_NTDO-13QSSF734 Qual Report.pdf

Please contact your local Microchip sales office with questions or concerns regarding this notification.

#### **Terms and Conditions:**

If you wish to <u>receive Microchip PCNs via email</u> please register for our PCN email service at our <u>PCN</u> <u>home page</u> select register then fill in the required fields. You will find instructions about registering for Microchips PCN email service in the <u>PCN FAO</u> section.

If you wish to <u>change your PCN profile</u>, <u>including opt out</u>, please go to the <u>PCN home page</u> select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections.